

CA1 - 271188.1

Express Mail No.: EL 451 596 512 US**PENNIE & EDMONDS LLP**COUNSELLORS AT LAW  
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(212) 790-9090ATTORNEY DOCKET NO. 10460-011-999Date: April 3, 2001Assistant Commissioner for Patents  
Box PATENT APPLICATION  
Washington, D.C. 20231

Sir:

The following utility patent application is enclosed for filing:

Applicant(s): Goh *et al.*

Executed on: unexecuted

Title of Invention: ETHER-AMINE BASED POLYMERIZATION CATALYSTS, COMPOSITIONS AND PROCESSES  
USING SAME**PATENT APPLICATION FEE VALUE**

TYPE	NO. FILED	LESS	EXTRA	EXTRA RATE	FEE
Total Claims	102	-20	82	\$18.00 each	\$ 1,476.00
Independent	7	-3	4	\$80.00 each	\$ 320.00
Minimum Fee					\$ 710.00
Multiple Dependency Fee If Applicable (\$270.00)					\$ 270.00
<b>Total</b>					\$ 2,776.00
50% Reduction for Independent Inventor, Nonprofit Organization or Small Business Concern (a verified statement as to the applicant's status is attached)					- \$
<b>Total Filing Fee</b>					\$ 2,776.00

- ☐ **DO NOT PUBLISH.** I hereby certify that the invention disclosed in the attached application **has not and will not be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).
- ☒ Priority of application no. 60/194,650 filed on April 4, 2000 in is claimed under 35 U.S.C. § 119.
- ☐ The certified copy of the priority application has been filed in application no. filed
- ☐ Amend the specification by inserting before the first line the following sentence: This is a continuation-in-part of application no. filed .

Please charge the required fee to Pennie &amp; Edmonds LLP Deposit Account No. 16-1150. A copy of this sheet is enclosed.

Respectfully submitted,

Sunil K. Singh  
PENNIE & EDMONDS LLP  
for Samuel B. Abrams (Reg. No. 30,605)

45,298

(Reg. No.)

Enclosure

This form is not for use with continuation, divisional, re-issue, design or plant patent applications.